



US00D892078S

(12) **United States Design Patent** (10) **Patent No.:** **US D892,078 S**
He (45) **Date of Patent:** **** Aug. 4, 2020**

(54) **HEADPHONE**

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(71) Applicant: **Harman International Industries, Incorporated**, Northridge, CA (US)

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(73) Assignee: **Harman International Industries, Incorporated**, Northridge, CA (US)

Design U.S. Appl. No. 29/631,192, filed Dec. 28, 2017.

(**) Term: **15 Years**

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(21) Appl. No.: **29/661,343**

(22) Filed: **Aug. 27, 2018**

(57) **CLAIM**

(51) **LOC (12) Cl.** **14-01**

The ornamental design for a headphone, as shown and described.

(52) **U.S. Cl.**

USPC **D14/205**

(58) **Field of Classification Search**

DESCRIPTION

USPC D14/205, 188, 192, 372; D29/112;
2/209; 181/129, 130, 135; 379/430, 431;
381/380, 381, 374, 370; 455/90.3, 575.1,
455/569.1

CPC H04R 25/00; H04R 1/1066; H04R 1/1016;
H04R 5/033; H04R 5/0335; H04R 1/1091

See application file for complete search history.

FIG. 1 is a perspective view of a headphone showing the new design;
FIG. 2 is a front elevational view thereof;
FIG. 3 is a rear elevational view thereof;
FIG. 4 is a side elevational view thereof;
FIG. 5 is an opposite side elevational view thereof;
FIG. 6 is a top view thereof;
FIG. 7 is a bottom view thereof;
FIG. 8 is a top perspective view thereof;
FIG. 9 is a bottom perspective view thereof;
FIG. 10 is a perspective view of another embodiment of the headphone showing the new design;
FIG. 11 is a front elevational view thereof;
FIG. 12 is a rear elevational view thereof;
FIG. 13 is a side elevational view thereof;
FIG. 14 is an opposite side elevational view thereof;
FIG. 15 is a top view thereof; and,
FIG. 16 is a bottom view thereof.

The broken lines immediately adjacent the shaded areas represent the bounds of the claimed design while all other

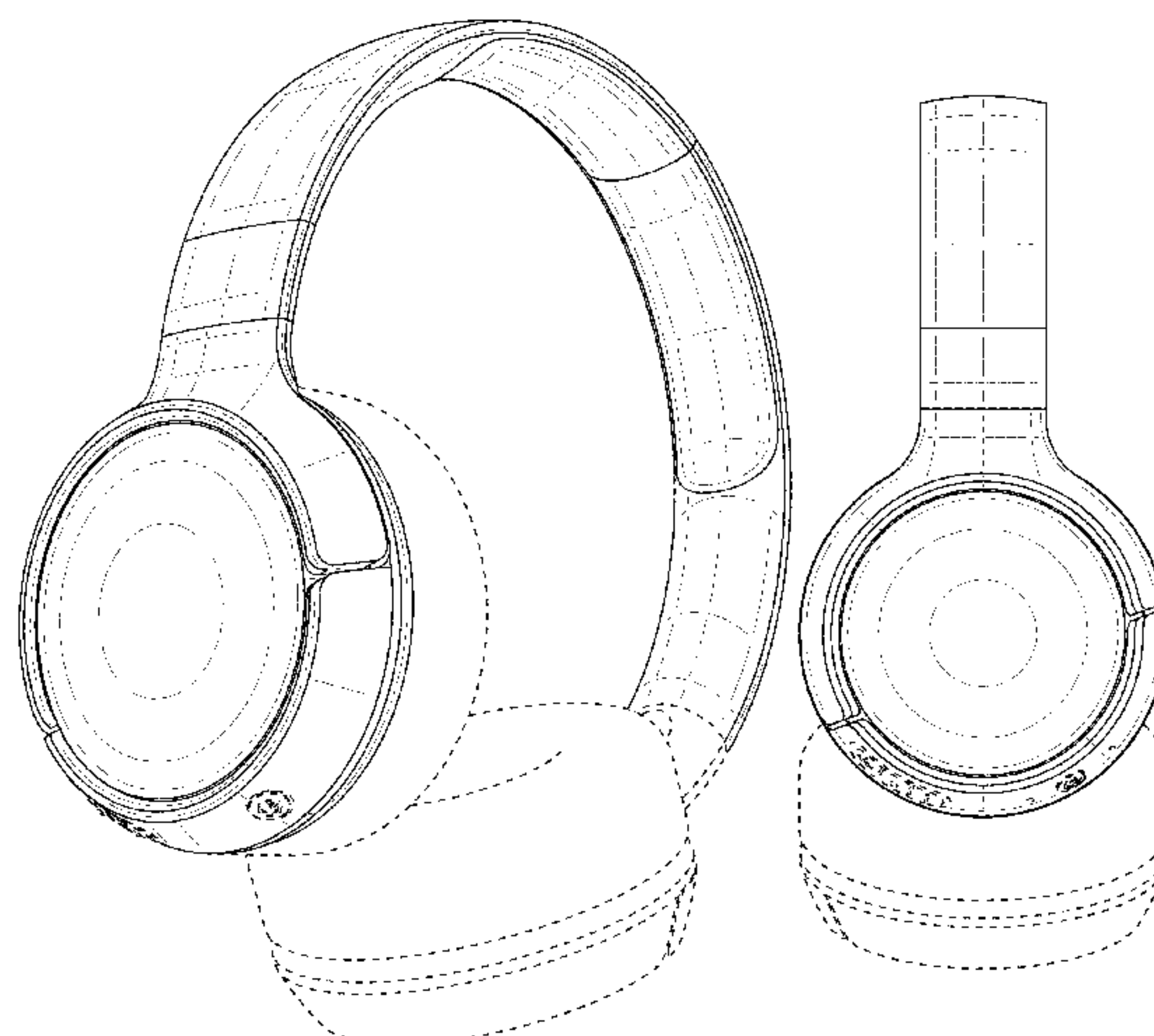
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broken lines are directed to environment and are for illustrative purposes only; the broken lines form no part of the claimed design.

1 Claim, 16 Drawing Sheets

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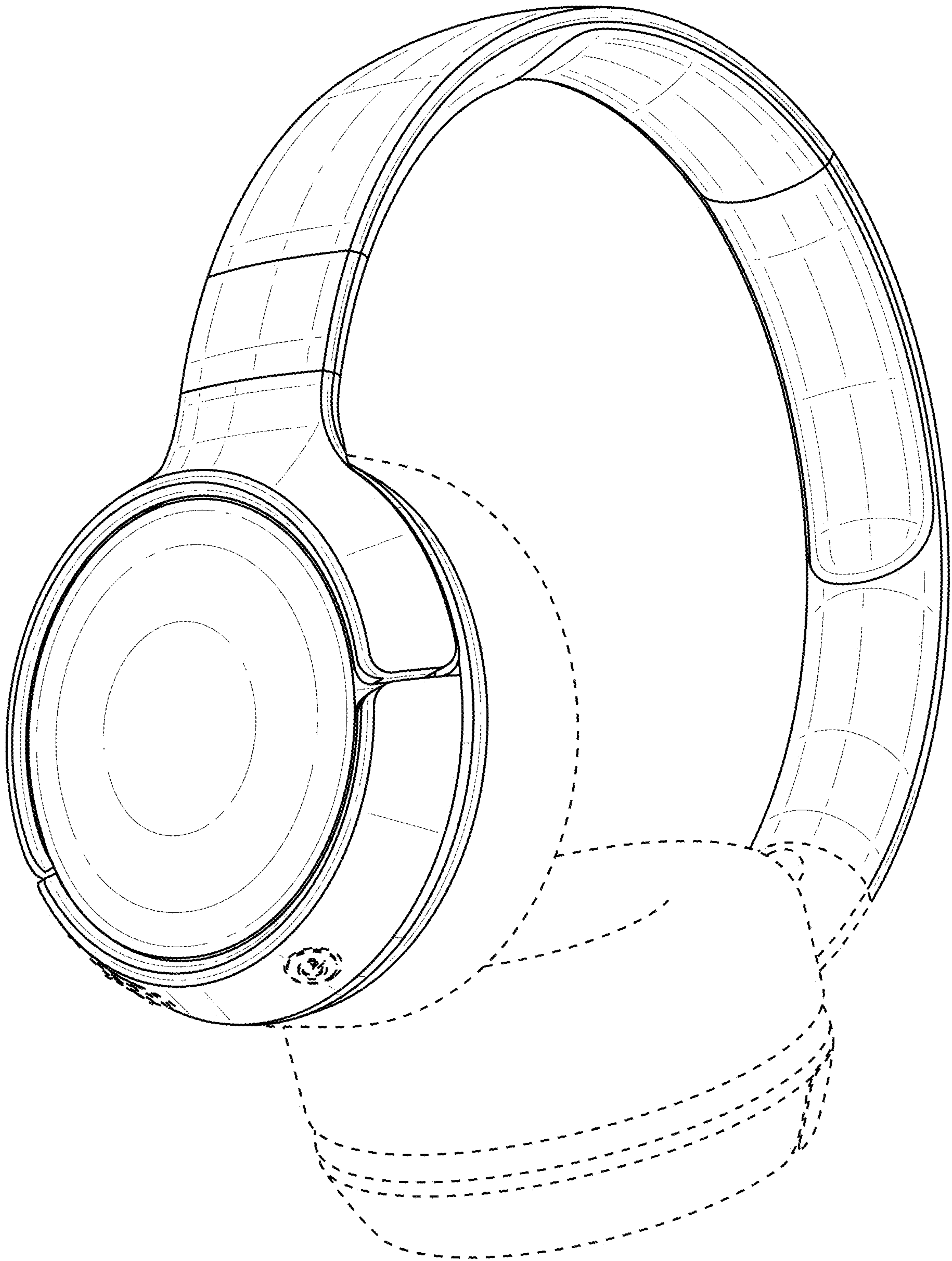


FIG. 1

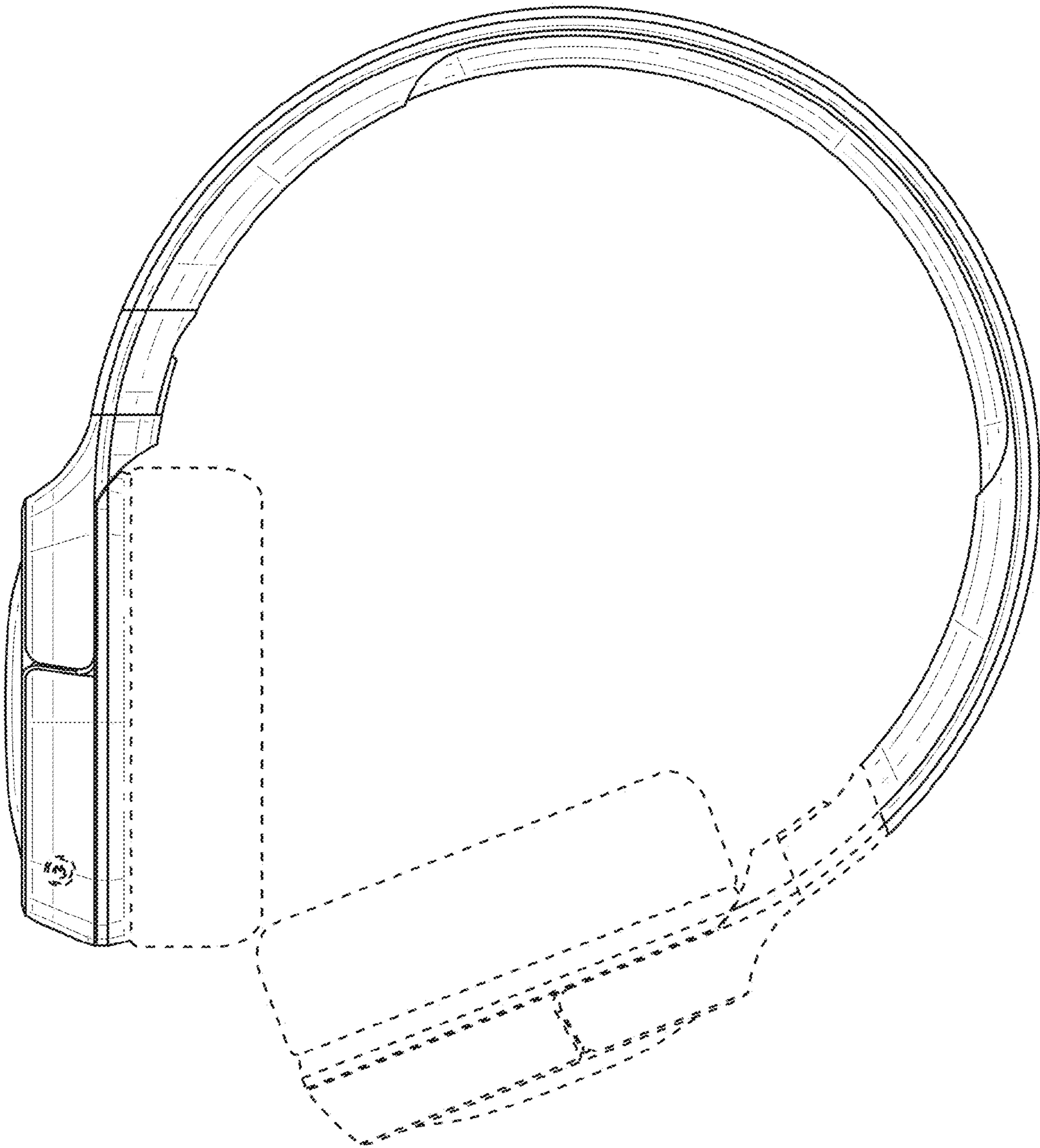


FIG. 2

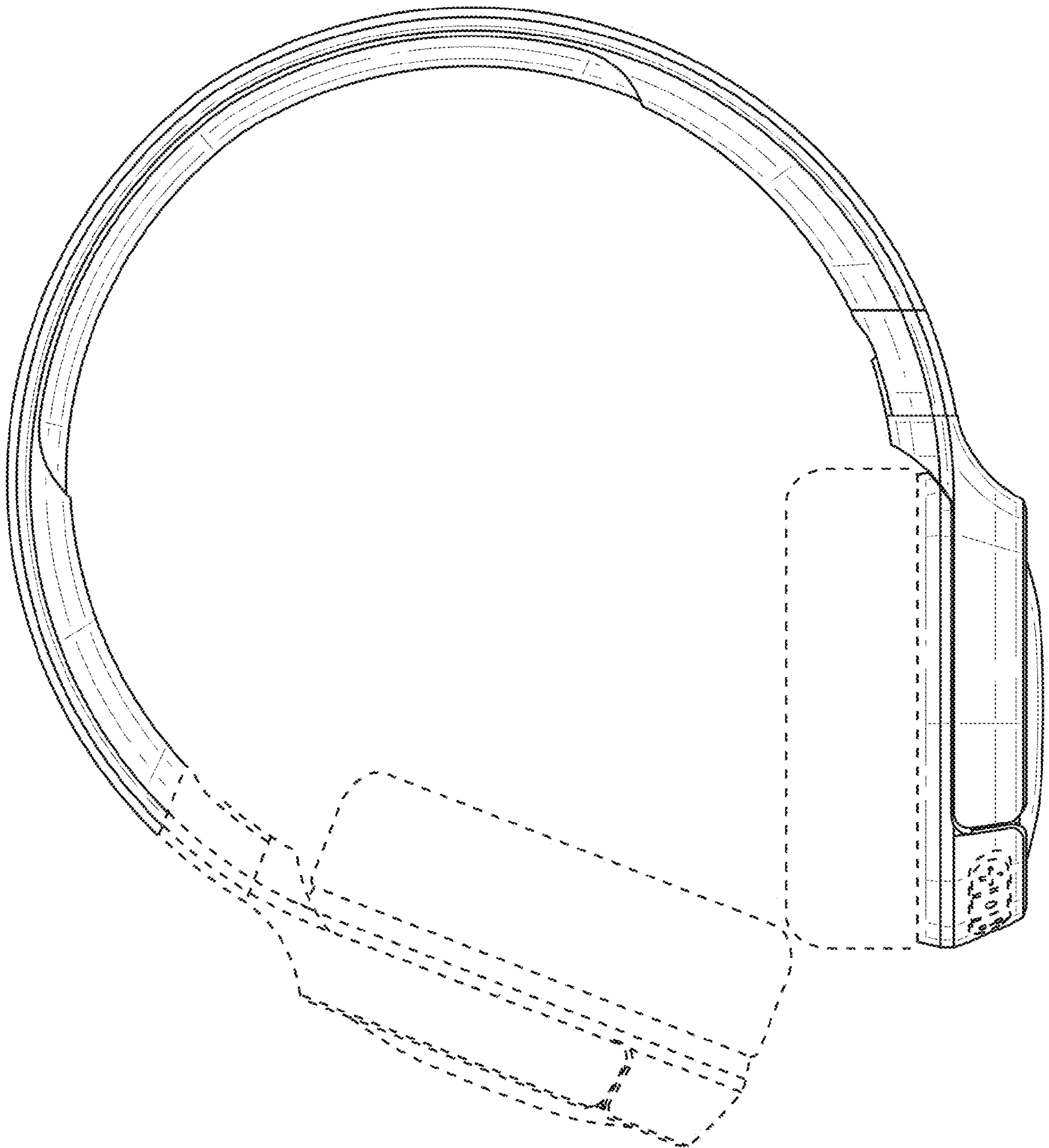


FIG. 3

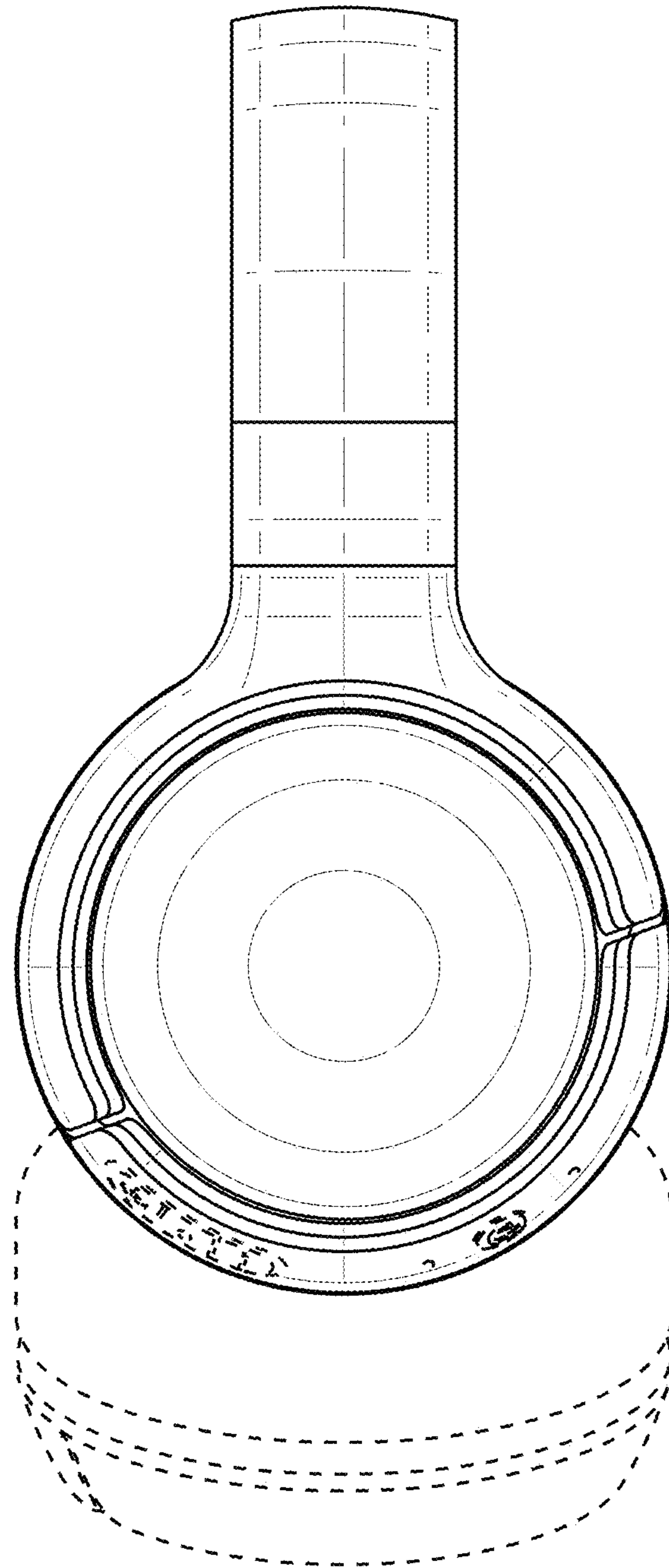


FIG. 4

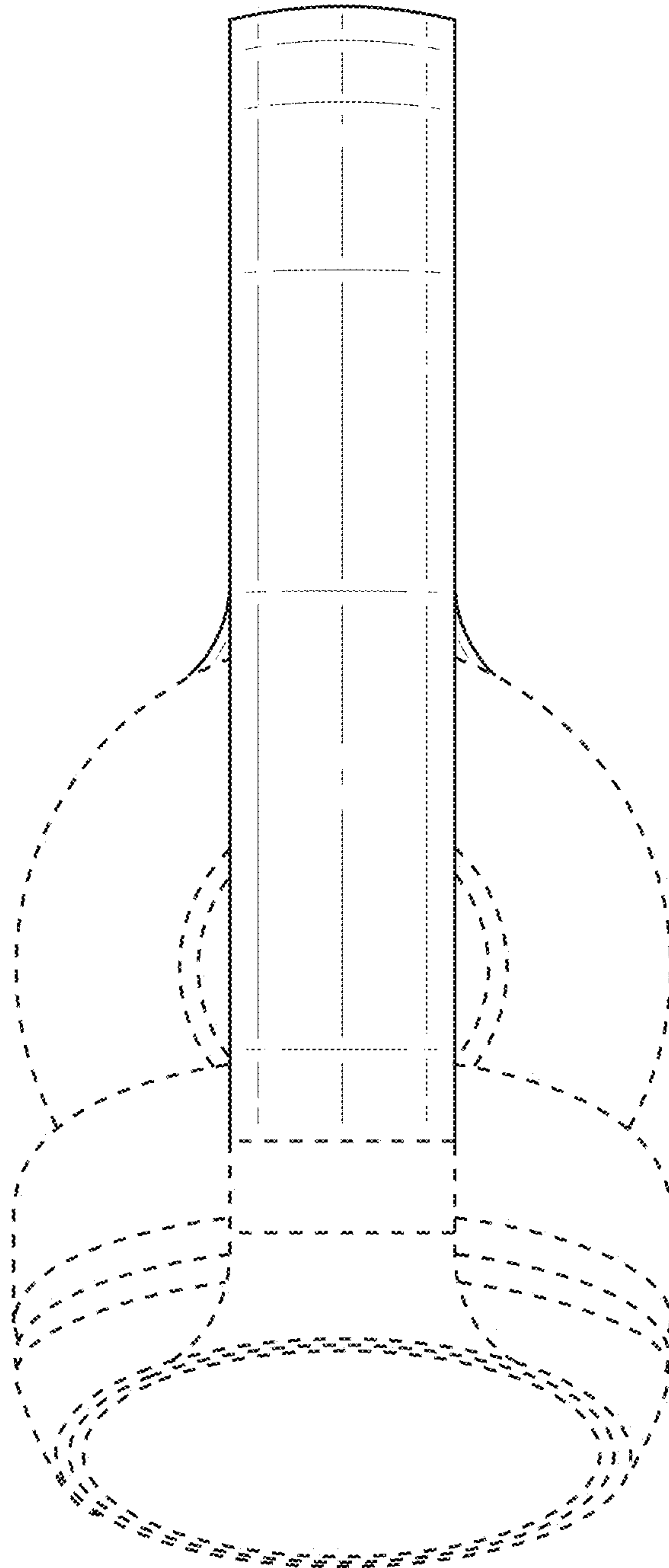


FIG. 5

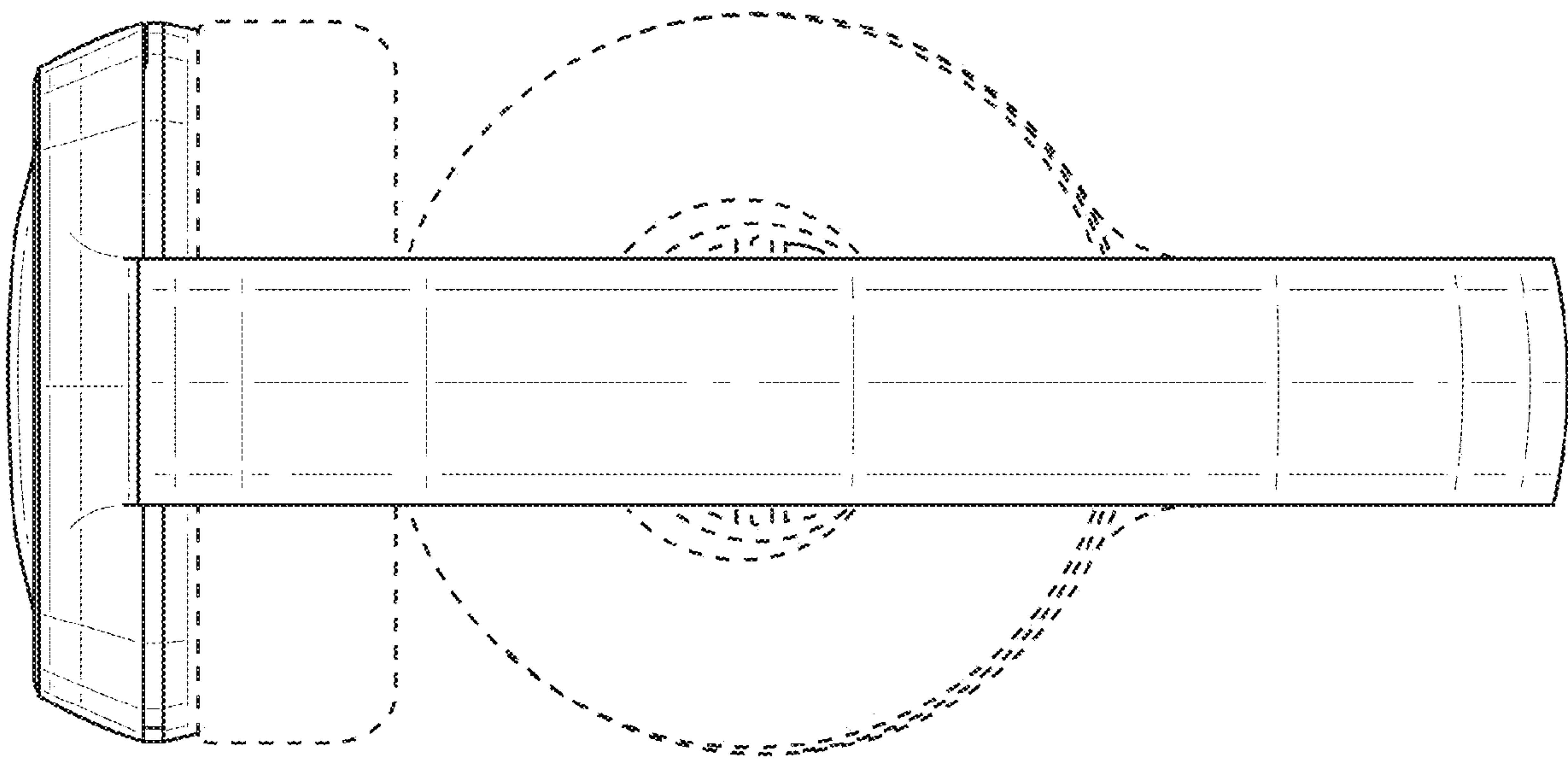


FIG. 6

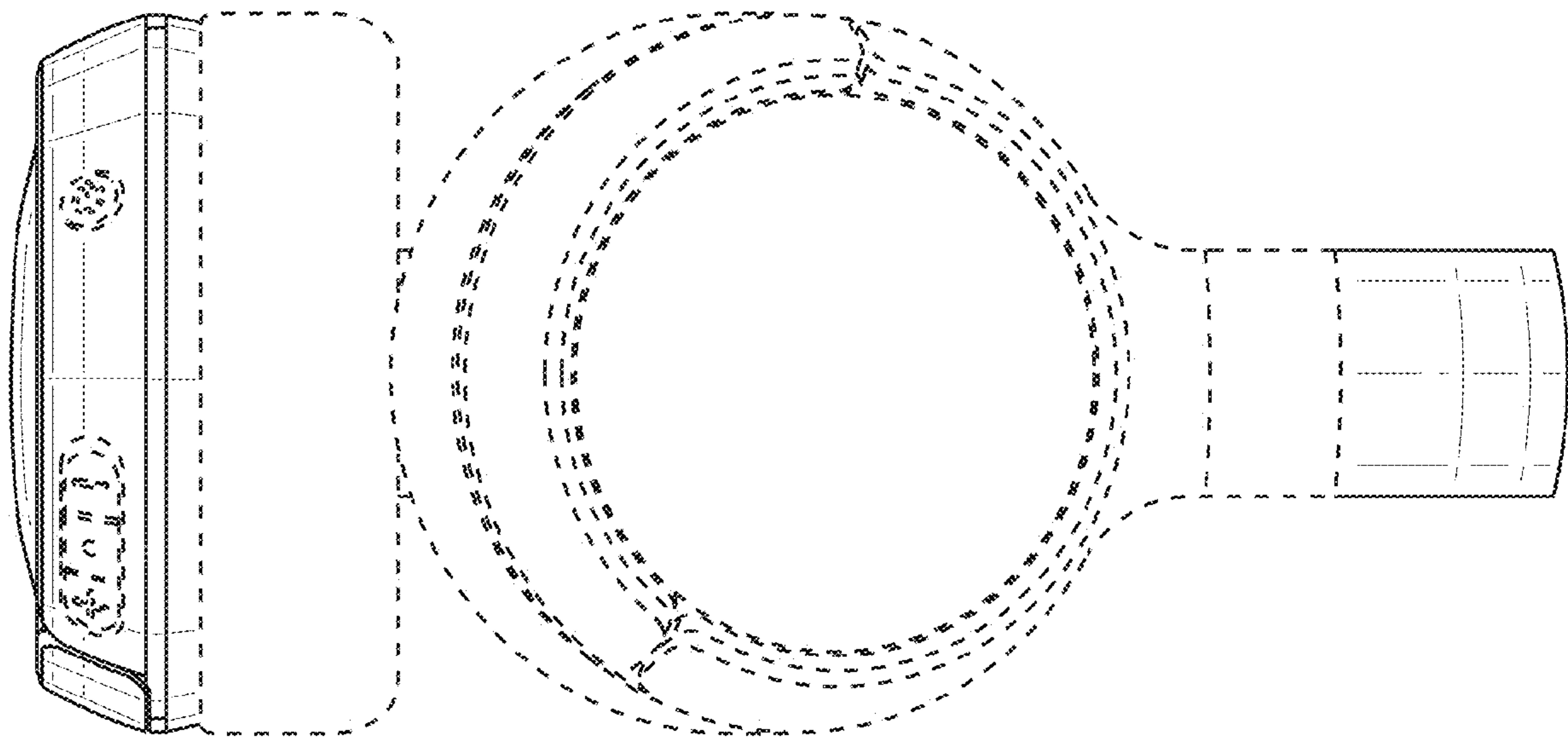


FIG. 7

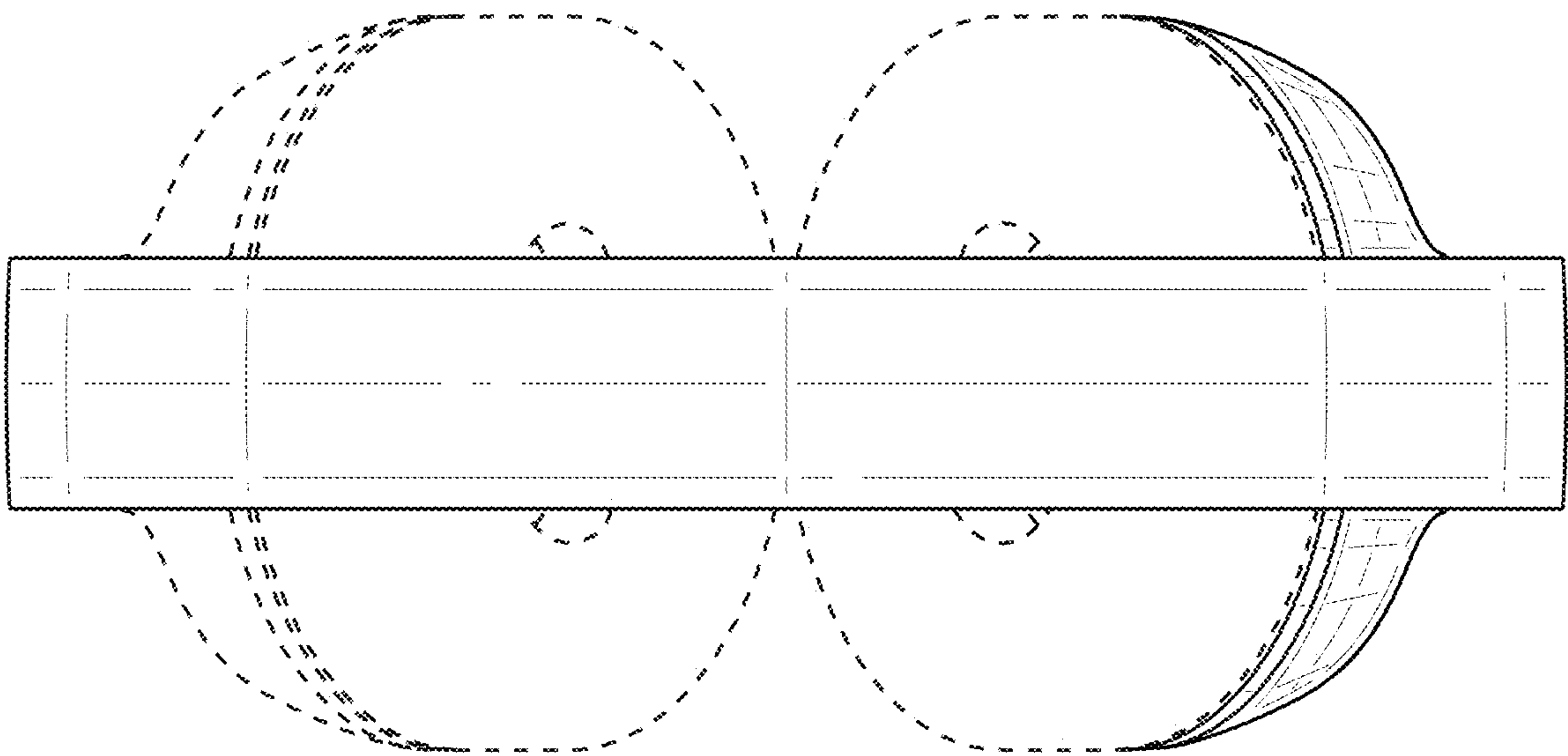


FIG. 8

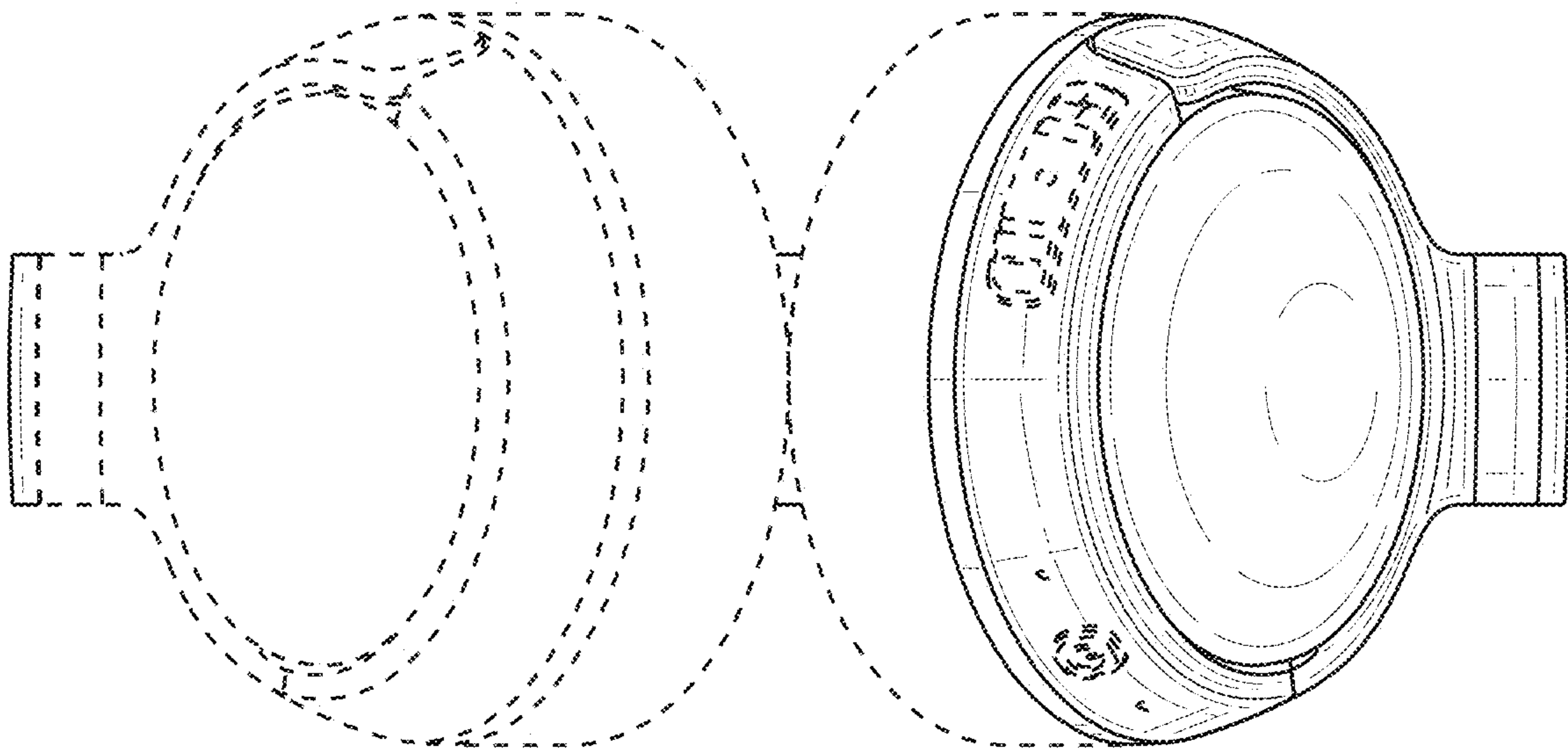


FIG. 9

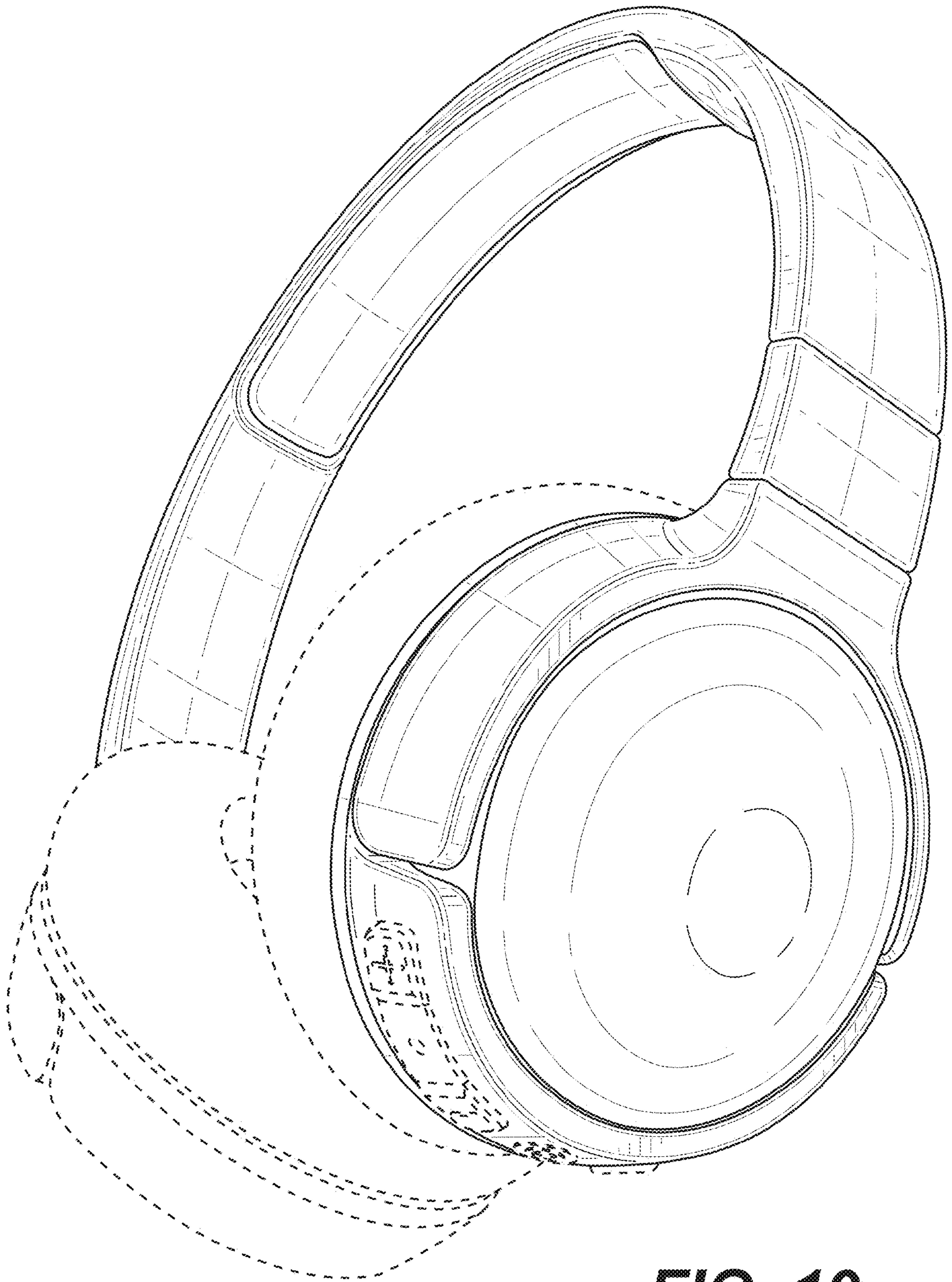


FIG. 10

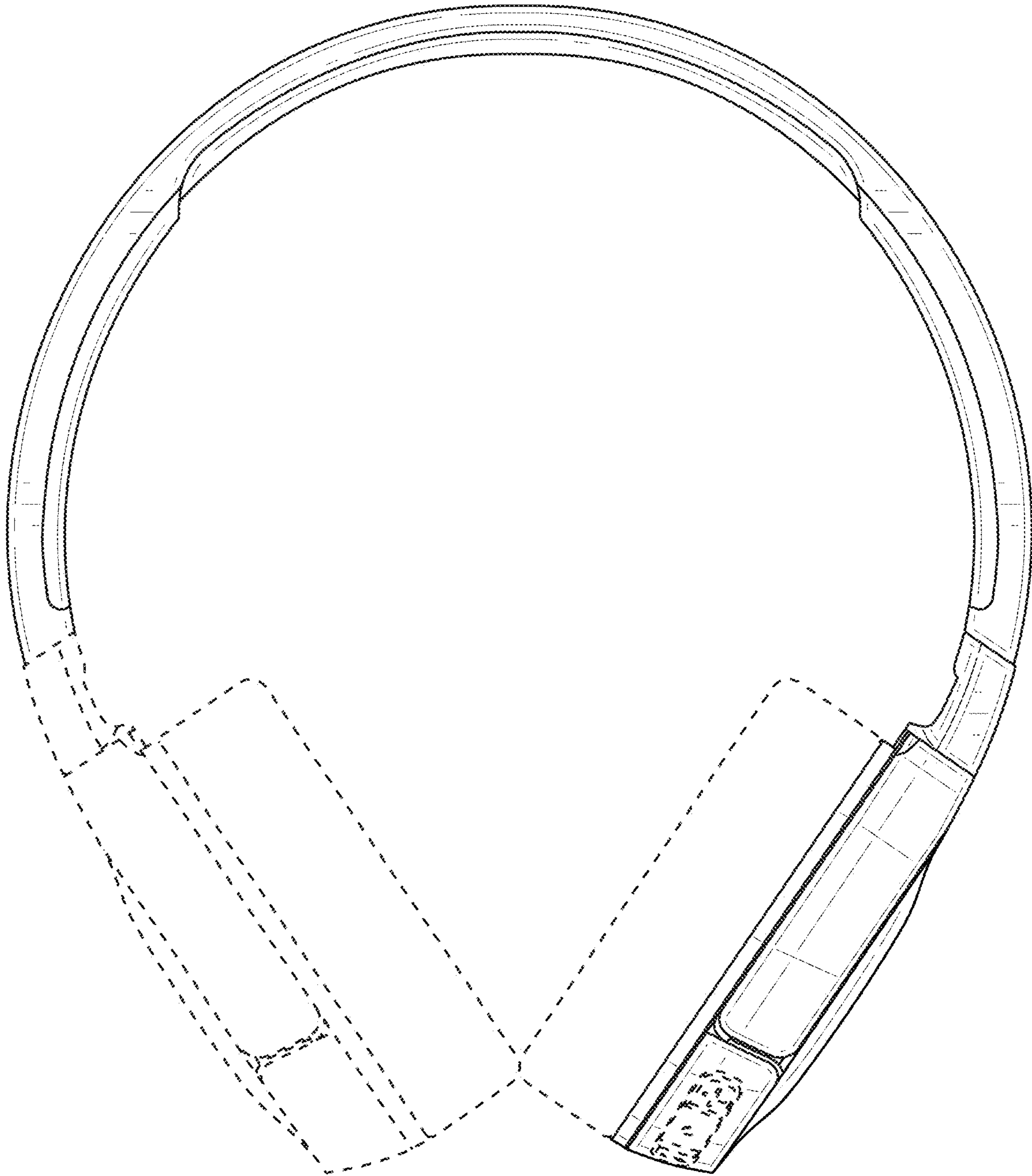


FIG. 11

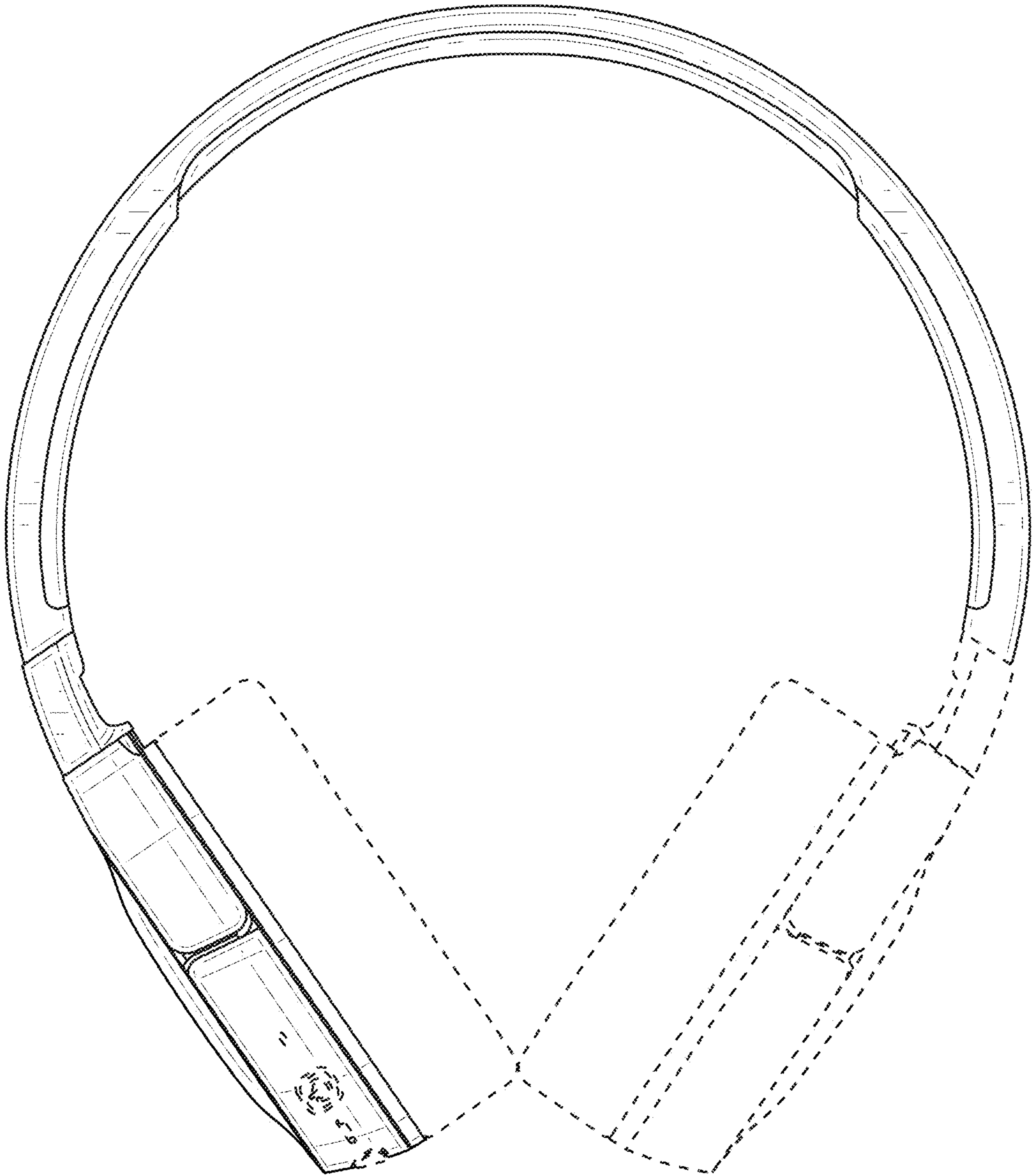


FIG. 12

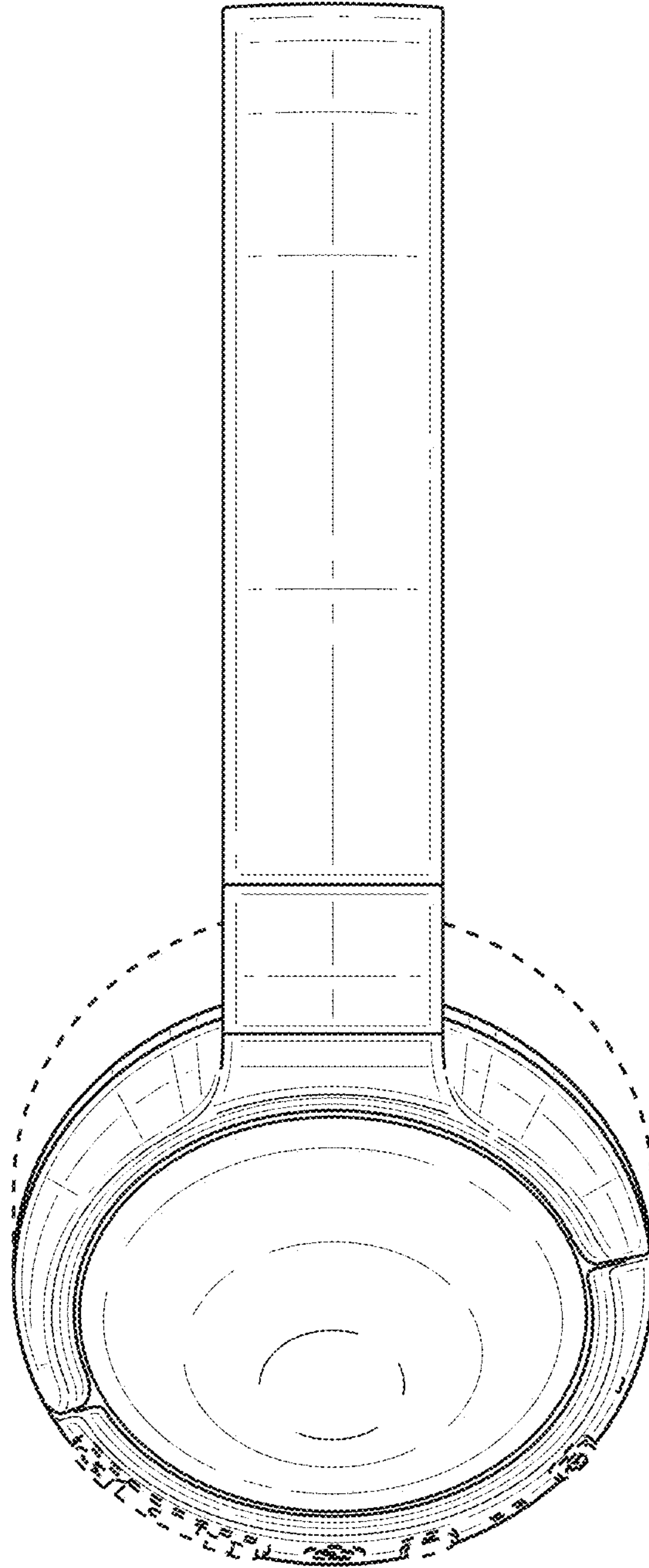


FIG. 13

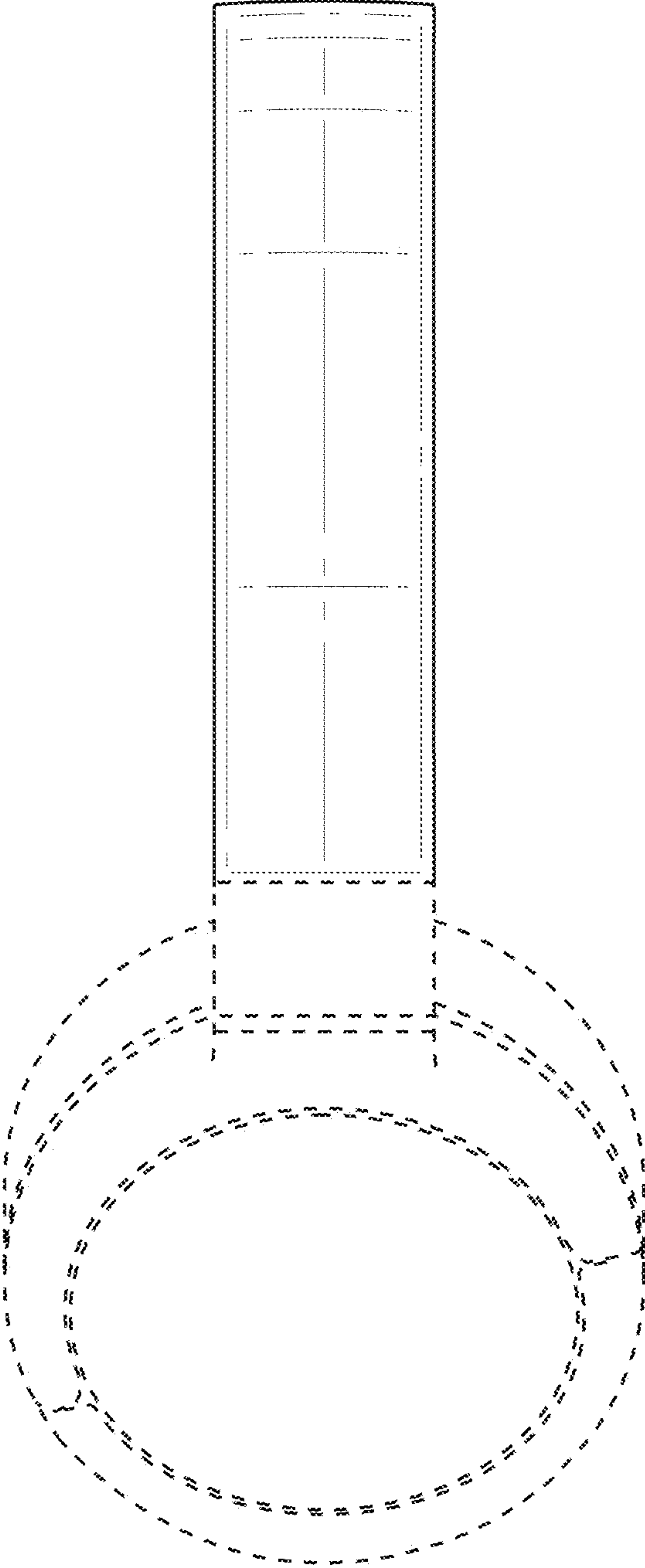


FIG. 14

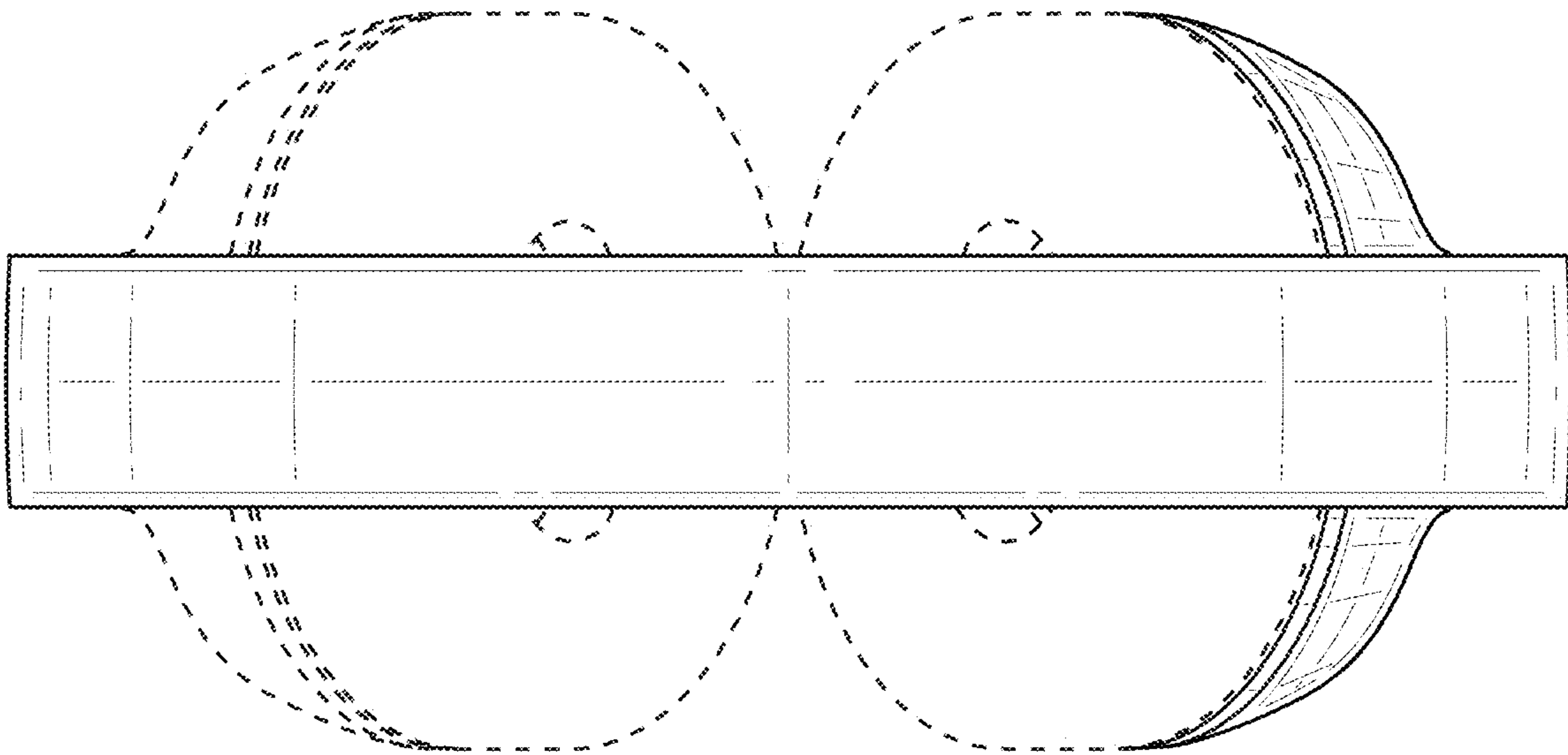


FIG. 15

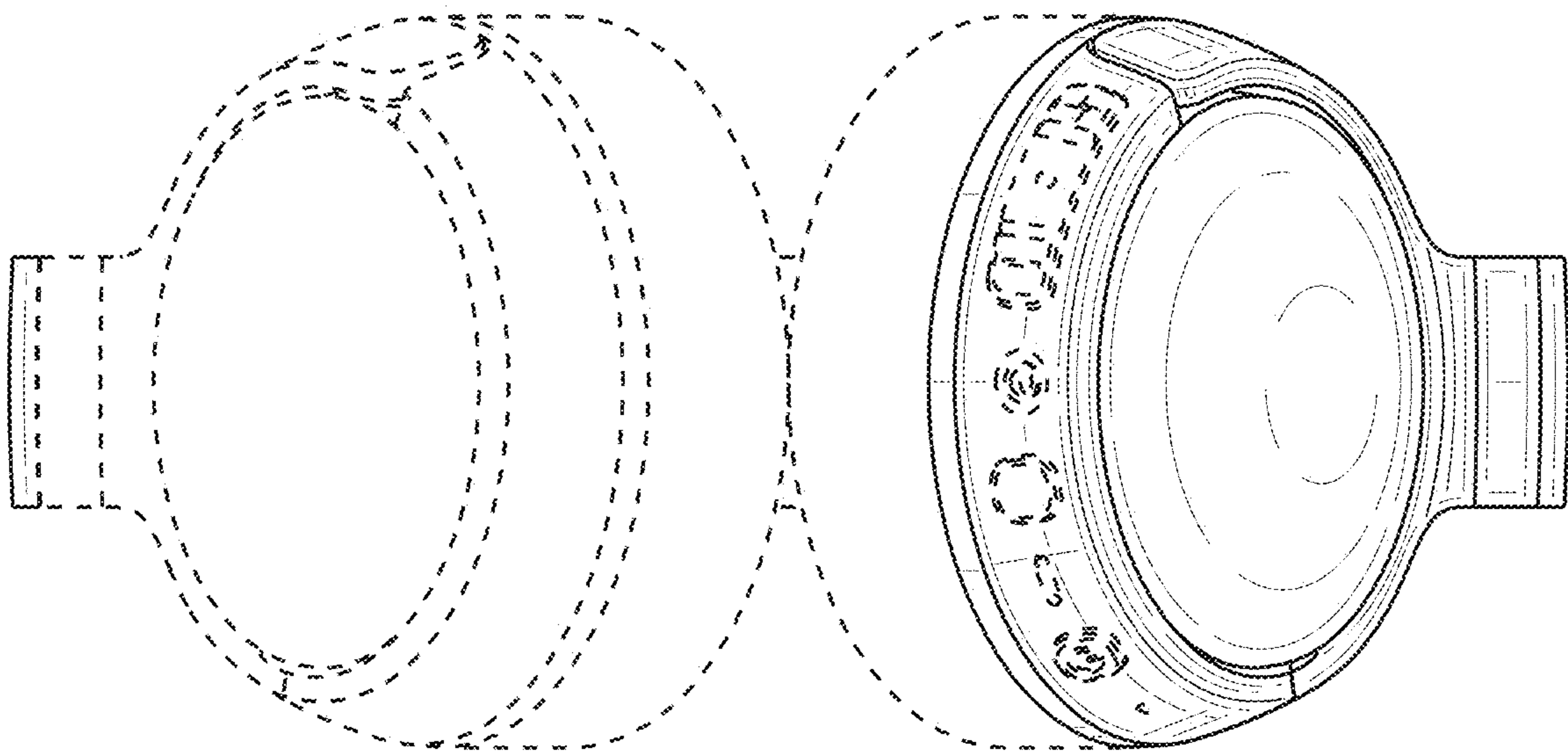


FIG. 16